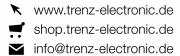


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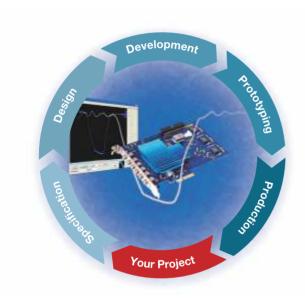




# trenz electronic

# **Company Profile**

Since 1992, Trenz Electronic GmbH successfully operates as a development service enterprise in the electronics branch. Our services include design-in support as well as turnkey design which typically cover all steps from product specification, hardware and software design up to prototyping and production.



We are particularly specialized in the design of high-speed data acquisition, high-accuracy measurement and embedded digital signal processing systems based on FPGA and ARM architectures.

We maintain long-term customer relationships, characterized by flexibility and technical competence.

#### **Hardware Design**

- System Architecture and Design
- Hardware Integration (Design-In)
- Ultrafast Digital Logic
- Analog and Mixed Signal
- Digital Signal Processing
- Schematic Capture and PCB Layout

#### **HDL Design**

- FPGA and System-On-Chip Design
- System Design and Synthesis
- HDL Design (VHDL, Verilog)
- Integration of Soft-Cores (Xilinx MicroBlaze, ARM Cortex ...)
- USB, PCI-Express, Gigabit Ethernet
- Ultrafast ADC/DAC Interfaces

#### **Software Development**

- Device Driver and Application Software development
- Software and Firmware development







ISO 14001:2004 (environmental management) certified

#### **Trenz Electronic GmbH**

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# TE0820 Series Xilinx Zyng UltraScale+, DDR4, SPI Boot Flash, eMMC





# **Key Features** (preliminary)

- Xilinx Zynq UltraScale+ MPSoC 784 pin package (ZU3EG, option ZU5EV)
- Memory:
  - 32-Bit DDR4 4 GByte max
  - SPI Boot Flash dual parallel 512 MByte max
  - 4 GByte eMMC (up to 64 GByte)
- · B2B connectors:

Plug-on module with 2 x 100-pin and 1 x 60-pin highspeed hermaphroditic strips

- 14 x MIO, 132 I/O's x HP (3 banks)
- Serial transceiver: PS GTR 4
- GT Reference clock input
- PLL for GT Clocks (optional external reference)
- 1 GBit Ethernet PHY
- USB 2.0 OTG PHY
- Real Time Clock
- Size: 40 x 50 mm
- · All power supplies on board.

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### **Overview**

The Trenz Electronic TE0820 are 4 x 5 standard footprint MPSoC modules integrating a Xilinx Zynq UltraScale+ with up to 4 GByte 32-Bit DDR4 SDRAM, and max. 512 MByte SPI Boot Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips.

All modules in  $4 \times 5$  cm form factor are fully mechanically and largely electrically compatible among them. All this on a tiny footprint, smaller than a credit card, at the most competitive price.

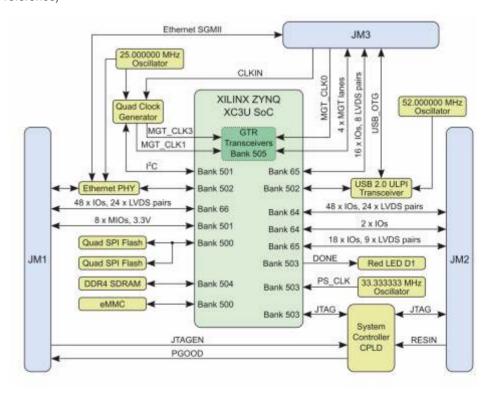
All modules produced by Trenz Electronic are developed and manufactured in Germany.



Rugged for industrial applications







# **TE0803 Series**

Xilinx Zynq UltraScale+, DDR4, SPI Boot Flash, Serial transceiver





# **Key Features** (preliminary)

- Xilinx Zynq UltraScale+ MPSoC 784 pin package (ZU3EG, optional ZU5EV)
- Memory:
  - 64-Bit DDR4 8 GByte max
  - SPI Boot Flash dual parallel 512 MByte max
- · B2B connectors:

Plug-on module with 4 x 160-pin connectors

- 65 x MIO, 156 I/O's x HP (3 banks)
- Serial transceiver: PS GTR 4, PL GT 4 (ZU4, ZU5 only)
- GT Reference clock input
- PLL for GT Clocks (optional external reference)
- Size: 52 x 76 mm
- All power supplies on board.
- Other assembly options for cost or performance optimization plus high volume prices available on request.

#### **Overview**

The Trenz Electronic TE0803 is an industrial-grade MPSoC module integrating a Xilinx Zynq UltraScale+ with up to 8 GByte 64-Bit width DDR4 SDRAM, and max. 512 MByte SPI Boot Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking connections.

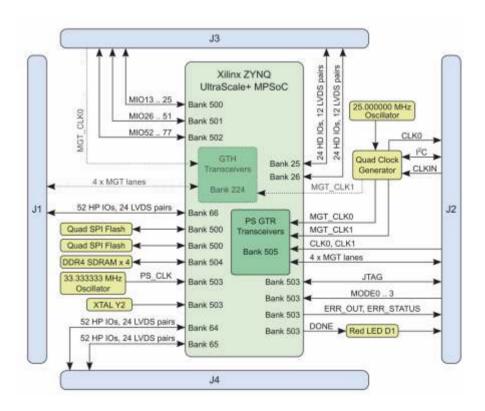
All this in a compact 5.2 x 7.6 cm form factor, at the most competitive price.













# **TEB0911 Series**

# Xilinx Zynq UltraScale+, 6 FMC Solts, Gigabit Ethernet



# **Key Features**

- Zynq UltraScale+ MPSoC 1156 Package ZU9 (ZU6, ZU9, ZU15 Possible as assembly option)
- 64-Bit DDR4 SODIMM (PS connected)
- PS-GTR
  - M2 PCle SSD (internal, 1-Lane)
  - 2 x USB3 Host (from 4 port internal HUB)
  - 2 Lane DisplayPort output Monitor
- RJ45 GbE Ethernet PS connected, 88E1512 PHY
- 4 x FMC-HPC connector front
  - 4 GTH
  - 1 GT Clock
  - 68+4 HP or HD I/O
- FMC-HPC connector Back
  - 4 GTH
  - 1 GT Clock
  - 12 I/O
- FMC-HPC connector Back
  - 1 GTH
  - 1 GT Clock
  - 12 I/O
- 2 x SFP+ connected to 2 PL GTH,
- 1 x SFP+ connected to PL GTH
- Power: 24V

# **Overview**

The Trenz Electronic TEB0911 "UltraRack+" is a high performance Zynq UltraScale+ MPSoC board with 6 FMC slots and Gigabit Ethernet.







# TE0808 UltraSOM+ Series Xilinx Zyng UltraScale+, DDR4, Flash, 20 x Transceiver





#### Overview

The Trenz Electronic TE0808 is an industrial-grade MPSoC module integrating a Xilinx Zynq UltraScale+, max. 8 GByte DDR4 SDRAM with 64-Bit width, max. 512 MByte Flash memory for configuration and operation, 20 Gigabit transceivers, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking connections.

All this in a compact  $5.2 \times 7.6 \text{ cm}$  form factor, at the most competitive price.

All modules produced by Trenz Electronic are developed and manufactured in Germany

# **Key Features**

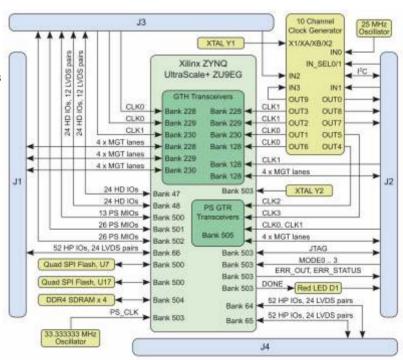
- SoC: ZYNQ UltraScale+ ZU9EG 900 pin package
- Memory
  - 4 x 512 MByte 64-Bit DDR4 (8 GByte max.)
  - 2 x 32 MByte SPI Boot Flash dual parallel (512 MByte max.)
- User I/O
  - 65 x MIO, 48 x HD (all), 156 x HP (3 banks)
  - Serial transceiver: GTR 4 (all) + GTH 16 (all)
  - GT clocks, I2C
  - PLL clock inputs and outputs
- Size: 52 x 76 mm
- 3 mm mounting holes for skyline heat spreader
- B2B connectors: 4 x 160 pin
- Si5345 10 output PLL
- All power supplies on board, single 3.3V Power required
  - 14 on-board DC/DC regulators and 13 LDO's
  - LP, FP, PL separately controlled power domains
- Support for all boot modes (except NAND) and scenarios
- Support for any combination of PS connected peripherals

Other assembly options for cost or performance optimization plus high volume prices available on request.











# **TEC0330 Virtex-7 PCIe FMC Carrier**



# **Key Features**

- FMC HPC
- 8 lane PCle Gen 2 capable
- Xilinx Virtex-7 XC7VX330T-2FFG1157C
- DDR3 SODIMM Socket
- 32 MByte SPI Flash
- LMK04828B Clock Synthesizer
- External Clock Input

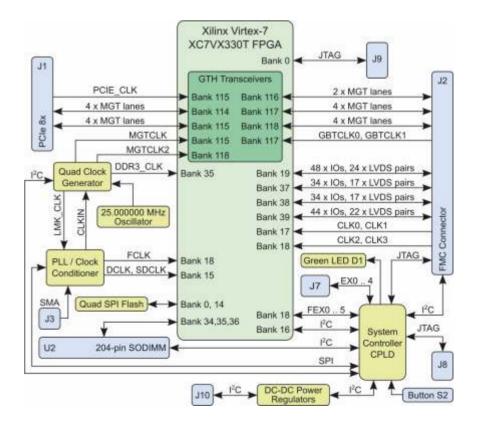
Other assembly options for cost or performance optimization plus high volume prices available on request.



and manufactured in Germany.



All modules produced by Trenz Electronic are developed





# TEF1001 Series electronic PCIe FMC Carrier, Xilinx Kintex-7, SPI Flash, 4 Iane PCIe



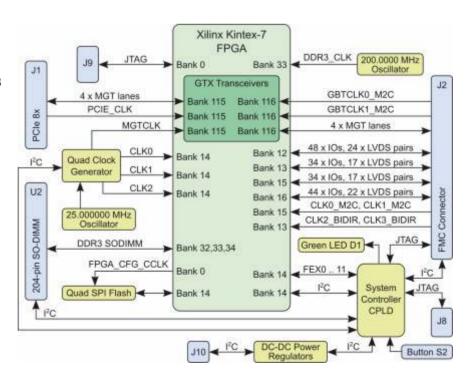
# **Key Features**

- One Vita 57.1 FMC HPC Slot
- 4 lane PCle Gen 2
- Xilinx Kintex-7 XC7K160T-2FBG676I
- DDR3 SODIMM Socket
- 32 MByte SPI Flash
- Programmable clock generator Si5338
- 200 MHz Low-Jitter LVDS oscillator
- High performance DC-DC converters

Other assembly options for cost or performance optimization plus high volume prices available on request.









# TE0745 Series Xilinx Zyng, 1 GByte DDR3, 32 MByte Flash, 1 GBit Ethernet





# **Key Features**

- Xilinx Zyng 7030/7035/7045
- · Rugged for shock and high vibration
- 1 GByte 32-Bit wide DDR3/L
- 32 MByte SPI Flash
- Dimensions: 5.2 x 7.6 cm
- B2B Connectors with 3 x 160 pin
  - 250 I/O's, all HR and HP I/O
  - 1 GBit Ethernet PHY,
  - USB 2.0 OTG PHY
  - 8 x GTX (7030: 4 GT)
  - 2 GT Reference Clock inputs (7030: 1 REFC
  - Reference clock input for PLL (optional)
  - 2 x PLL outputs
  - I2C
  - 6 MIO
- · Real Time Clock
- MAC Address EEPROM
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

The Trenz Electronic TE0745 is an industrial-grade SoC module integrating a Xilinx Zvng-7 (Z-7030, Z-7035, Z-7045). 1 GByte 32-Bit wide DDR3/L, 32 MByte SPI Flash memory for configuration and operation and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips.

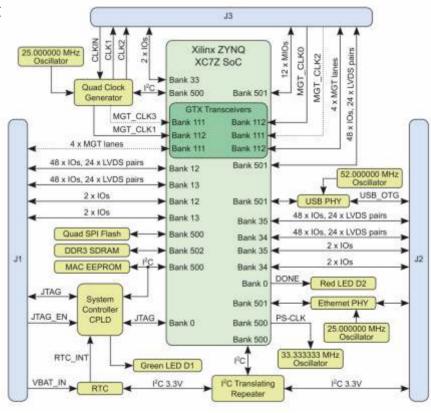
All this on a tiny footprint, smaller than a credit card, at the most competitive price.











# TE0729 Series

Xilinx Zynq, 1x Gig ETH, 512 MByte DDR3, 2x 100MBit ETH, 4 GByte eMMC, 3.3V Only





# **Key Features**

- Zyng XC7Z020-2CLG484I
- · Rugged for shock and high vibration
- 2 x ARM Cortex-A9
- 1 x 10/100/1000 Mbps Ethernet transceiver PHY
- 2 x 10/100 Mbps Ethernet transceiver PHYs
- 3 x MAC-Address EEPROMs
- 16-Bit wide 512 MByte DDR3 SDRAM
- 32 MByte QSPI-Flash-Memory
- 4 GByte e-NAND-Flash-Memory (embedded eMMC Memory)
- · USB 2.0 high-speed ULPI transceiver
- Plug-on module with 2 x 120-pin high-speed hermaphroditic strips
- 136 FPGA I/O's (58 LVDS pairs possible) and 14 MIO's available on
- · board-to-board connectors
- · On-board high-efficiency DC-DC converters
  - 4.0 A x 1.0 V power rail
  - 1.5 A x 1.5 V power rail
  - 1.5 A x 1.8 V power rail
  - 1.5 A x 2.5 V power rail
- · System management
- eFUSE bit-stream encryption
- · AES bit-stream encryption
- Temperature compensated RTC (real-time clock)
- · User LED
- Evenly spread supply pins for good signal integrity
- 3 mm mounting holes for Skyline heat spreader
- · Cooling Solution available

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

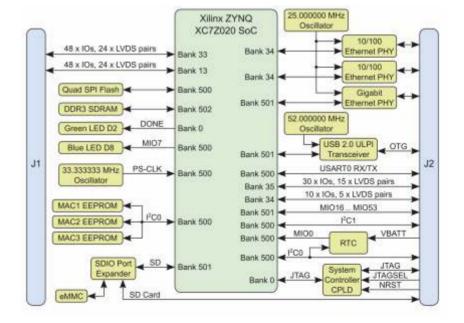
The Trenz Electronic TE0729 is an industrial-grade SoC module integrating a Xilinx Zyng-7020 with a Gigabit Ethernet transceiver, 2 x 100 MBit Ethernet, 512 MByte DDR3 SDRAM, 32 MByte Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips.











# **TE0715 Series**

Xilinx Zyng, Cortex-A9, DDR3, Flash, GBit Ethernet, 4 x Transceiver





# **Key Features**

- Industrial-grade Xilinx Zynq-7000 (Z-7015, Z-7030) SoM, supported by the free Xilinx Vivado WebPACK tool
- Rugged for shock and high vibration
- ARM dual-core Cortex-A9
- 10/100/1000 tri-speed gigabit Ethernet transceiver (PHY) with SGMII
  - MAC Address EEPROM
- 32-Bit-wide 1 GByte DDR3 SDRAM
- 32 MByte QSPI Flash memory (with XiP support)
- Programmable clock generator
  - Transceiver clock (default 125 MHz)
- Plug-on module with  $2 \times 100$ -pin and  $1 \times 60$ -pin high-speed hermaphroditic strips
- 132 FPGA I/O's (65 LVDS pairs possible) and 14 PS-MIO available on board-to-board connectors
- 4 GTP/GTX (high-performance transceiver) lanes GTP/GTX (high-performance transceiver) clock input
- USB 2.0 high-speed ULPI transceiver
- On-board high-efficiency DC-DC converters
  - 4.0 A x 1.0 V power rail
  - 1.5 A x 1.5 V power rail
  - 1.5 A x 1.8 V power rail
- · System management
- eFUSE bit-stream encryption
- AES bit-stream encryption
- Temperature compensated RTC (real-time clock)
- User LED
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

Trenz Electronic TE0715 are industrial-grade SoC modules integrating a Xilinx Zynq-7000 SoC, a gigabit Ethernet transceiver (physical layer), 1 gigabyte DDR3 SDRAM with 32-Bit width, 32 megabyte Flash memory for configuration and operation, 4 transceivers, a USB ULPI transceiver, and powerful switch-mode power supplies for all onboard voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips. All modules in 4 x 5 cm form factor are mechanically compatible.

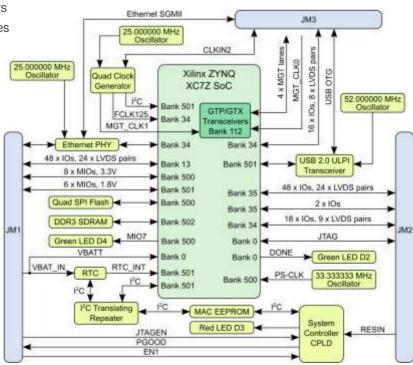
All this on a tiny fooprint, smaller than a credit card, at the most competitive price.











# **TE0720 Series**

Xilinx Zyng, 2 × Cortex-A9, DDR3, Flash, GBit Ethernet, USB





# **Key Features**

- Industrial-grade Xilinx Zyng 7020 SoM, supported by the free Xilinx Vivado WebPACK tool
- · Rugged for shock and high vibration
- ARM Dual Core Cortex-A9
- 10/100/1000 tri-speed gigabit Ethernet transceiver (PHY) with SGMII
  - MAC Address EEPROM
- 32-Bit-wide 1 GByte DDR3 SDRAM
- 32 MByte QSPI Flash memory (with XiP support)
- 4 GByte (up to 32 GB) e-NAND
- Plug-on module with  $2 \times 100$ -pin and  $1 \times 60$ -pin high-speed hermaphroditic strips
- 152 FPGA I/O's (75 LVDS pairs possible) and 14 PS-MIO available on board-to-board connectors
- USB 2.0 high-speed ULPI transceiver
- On-board high-efficiency DC-DC converters
  - 4.0 A x 1.0 V power rail
  - 1.5 A x 1.5 V power rail
  - 1.5 A x 1.8 V power rail
- · System management and power sequencing
- eFUSE bit-stream encryption
- AES bit-stream encryption
- Temperature compensated RTC (real-time clock)
- 3 user LEDs
- Optional MEMS sensor (3D accelerometer and 3D magnetometer)
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

Trenz Electronic TE0720 are industrial-grade SoC modules integrating a Xilinx Zynq-7000 SoC, a gigabit Ethernet transceiver, 1 gigabyte DDR3 SDRAM with 32-Bit width, 32 megabyte Flash memory for configuration and operation, a USB ULPI transceiver, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips. All modules in 4 x 5 cm form factor are mechanically compatible.

All this on a tiny footprint, smaller than a credit card, at the most competitive price.

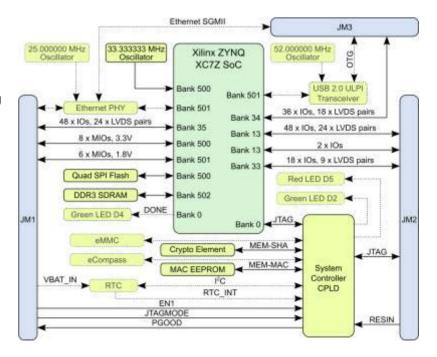
All modules produced by Trenz Electronic are developed and manufactured in Germany.



Rugged for industrial applications







### **TE0728 Series**

Xilinx Zynq, 2 × Cortex-A9, DDR3, Flash, 2 × Ethernet, CAN, Automotive





# **Key Features**

- Xilinx Zynq XA7Z020-1CLG484Q (Automotive)
- · Rugged for shock and high vibration
- 2 x ARM Cortex-A9 MPCore
- 2 x 100 MBit Ethernet transceiver (PHY)
- 16-Bit-wide 512 MByte DDR3 SDRAM
- 16 MByte QSPI Flash memory (with XiP support)
- Plug-on module with 3 x 80-pin high-reliability highspeed strips
- 76 single ended I/O, 24 LVDS pairs (48 I/O) and 42 MIO available on
- board-to-board connectors
- Board-to-board connectors
- CAN transceiver (PHY)
- Temperature compensated RTC (real-time clock)
- 12 V power supply with watchdog
- On-board high-efficiency DC-DC converters
- System management and power sequencir
- eFUSE bit-stream encryption
- AES bit-stream encryption
- 3 user LEDs
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

The Trenz Electronic TE0728-04-1Q is a SoC module integrating a Xilinx Automotive Zyng-7020, 512 MByte DDR3 SDRAM with 16-Bit width, 16 MByte Flash Memory for configuration and operation, two 100 Megabit Ethernet transceivers, and powerful switch-mode power supplies for all on-board voltages. A large number of con?gurable I/O's is provided via rugged high-speed stacking strips.

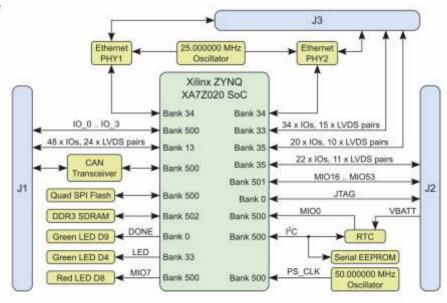
Within the complete module only Automotive components are installed. All this in a compact 6 x 6 cm form factor, at the most competitive price.











# **TE0782 Series**

Xilinx Zyng,  $2 \times$  Cortex-A9, DDR3, Flash,  $2 \times$  GBit Ethernet,  $2 \times$  USB,  $16 \times$  Transceiver





# **Key Features**

- Industrial-grade Xilinx Zynq-7 XC7Z035, XC7Z045 or XC7Z100 SOM
- Rugged for shock and high vibration
- Dual ARM Cortex-A9 MPCore
- · Real Time Clock
- 2 x Hi-Speed USB2.0 ULPI Transceiver PHY
- 2 x Gigabit Ethernet Transceiver PHY
- 2 x Ethernet MAC Address EEPROM
- 1 GByte DDR3 SDRAM
- 32 MByte QSPI Flash memory
- 4 GByte eMMC (optional up to 64 GByte)
- Optional 2 x 8 MByte HyperRAM (max 2 x 32 MByte HyperRAM)
- Si5338 PLL for GTX clocking
- Plug-on module with 3 x 160-pin high-speed strips
- 16 GTX high-performance tranceiver lanes, GTX high-performance
- Transceiver clock input
- 254 FPGA I/O's (125 LVDS pairs possible) available on board-to-board connectors
- On-board high-efficiency DC-DC converters
- · System management and power sequencing
- eFUSE bit-stream encryption
- AES bit-stream encryption
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### Overview

The Trenz Electronic TE0782 are industrial-grade SoC modules integrating a Xilinx Zyng-7 XC7Z035, XC7Z045 or XC7Z100, 1 GByte DDR3 SDRAM, 4 GByte eMMC, 16 GTX high-performance transceiver lanes, 32 MByte QSPI Flash memory for configuration and operation, and powerful switchmode power supplies for all on-board voltages.

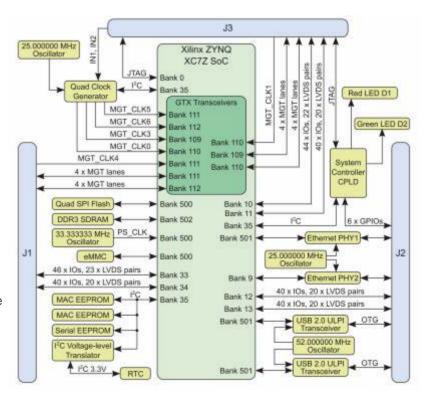
A large number of configurable I/O's is provided via rugged high-speed stacking strips. All this in a 8.5 x 8.5 cm form factor at the most competitive price.











# **TE0723 Series**

Xilinx Zynq, 2x ARM Cortex A9, DDR3L Memory, USB OTG, On-board USB JTAG and UART





# **Key Features**

- Xilinx XC7Z010-1CLG225C
- · Form Factor: Arduino Shield
- Dual ARM Cortex-A9
- Up to 512 MByte DDR3L
- 16 MByte SPI Flash memory
- 12 MHz MEMS Oscillator low power consumption
- · Hi-Speed USB2.0 ULPI Transceiver
- 23 FPGA I/O's available on board-to-board connectors
- MicroSD Card socket
- · Micro USB OTG
- RGB LED (PL I/O connected)
- "Done" LED (inverted polarity)
- On-board USB JTAG and UART
- CERN Open Hardware Licence 1.2

Other assembly options for cost or performance optimization available or high volume prices on request.

# Overview

The Trenz Electronic TE0723 is a Arduino compatible FPGA module integrating a Xilinx Zvng-7010, 512 MBvte DDR3L. and 16 MByte SPI Flash Memory for configuration and operation.

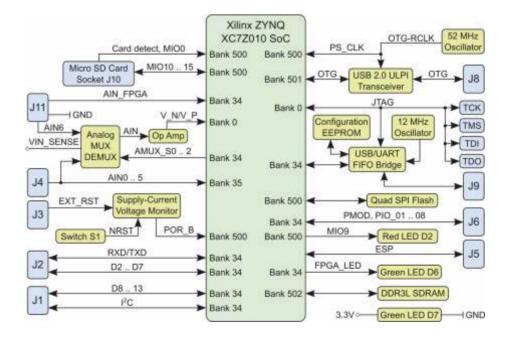
The "ArduZyng" is the lowest cost, Linux ready solution to use the latest FPGA: the Xilinx 7 series. Use it as a FPGA development platform, or run Linux on the Cortex A9 cores.













# TE0726 Series

Xilinx Zyng, 512 MByte DDR3L SDRAM, 16 MByte Flash, 100 MBit Ethernet RJ45





#### Overview

The Trenz Electronic TE0726 is a Rasberry Pi compatible FPGA module integrating a Xilinx Zyng-7010, 512 MByte DDR3L SDRAM, 4 USB ports, an Ethernet port and 16 MByte Flash memory for configuration und operation.

All modules produced by Trenz Electronic are developed and manufactured in Germany.





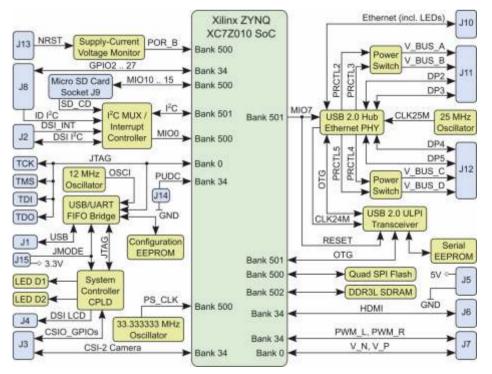




# **Key Features**

- Xilinx Zynq XC7Z010-1CLG225C
  - 512 MByte DDR3L SDRAM
  - 16 MByte Flash
- LAN9514 USB Hub with Ethernet
  - 4 x USB with power switches
  - 100 MBit Ethernet RJ45
- · Micro SD card slot
- HDMI Typ A
- DSI Connector (Display)
- CSI-2 Connector (Camera)
- · Micro USB
  - power input
  - USB UART
  - JTAG ARM- und FPGA-Debug
- 3.5 mm audio plug (PWM Audio output only)
- · Raspberry Pi Model 2 form faktor
- HAT header with 26 I/O's

Other assembly options for cost or performance optimization plus high volume prices available on request.



### **TE0722 Series**

Xilinx Zyng, Dual Core ARM A9+, 16 MByte SPI Flash, DIP40 Form Factor





# **Key Features**

- Xilinx Zynq-7: XC7Z010-CLG225
  - 16 MByte SPI Flash (primary boot)
  - 33.333 MHz Clock (MEMS Oscillator)
- Dual Core ARM A9+
- · DIP40 form factor
  - 2 x 20 holes for socket pins or pin-header
  - Size: 18 x 51 mm
- Total user accessible PL I/O: 46 (+3 Input only)
  - DIP40 header pins: 34 I/O
  - XMOD J1: 6 I/O
  - XMOD J2: JTAG + 2 I/O (or 3 input + 2 I/O)
  - XMOD J3: 4 I/O
- 3.3V single supply
- RGB LED (PL I/O connected)
- "Done" LED (inverted polarity)
- User LED (ARM CPU MIO GPIO)
- MicroSD Card socket (MIO, ZYNQ secondary boot media)
- · Sil1143 Proximity and ambient light sensor

Other assembly options for cost or performance optimization available or high volume prices on request.

#### Overview

The DIPFORTy1 "Soft Propeller" is based on the Xilinx Zyng-7000, a System on Chip which contains a FPGA and a Dual Core ARM A9+ processor with enough logic gates to become a Propeller. The board also has 16 MByte of Flash used for configuration and everything fits on a Propeller-compatible DIP

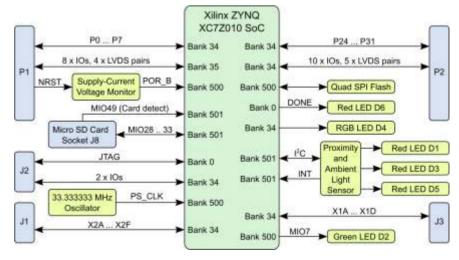
DIPFORTy1 "Soft-Propeller" is the lowest cost Zyng based module ever made and the first Zyng module that can use existing bases and project boards (Parallax Propeller chip compatibility). All this in a compact 1.8 x 5.1 cm form factor, at the most competitive price.













# TE0841 Series Xilinx Kintex UltraScale, DDR4, Flash, 8 x Transceiver





### **Overview**

The Trenz Electronic TE0841 is an industrial-grade FPGA module integrating a Xilinx Kintex UltraScale KU35 or KU40, max. 4 GByte 16-Bit width DDR4, max. 256 MByte QSPI Flash for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips.

All this on a tiny footprint, smaller than a credit card, at the most competitive price.

All modules produced by Trenz Electronic are developed and manufactured in Germany.

# **Key Features**

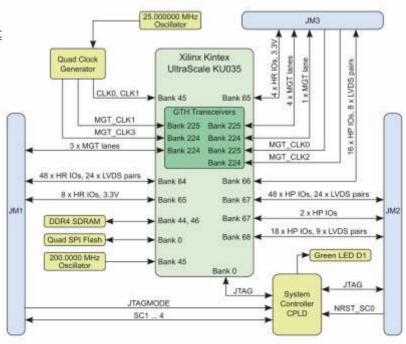
- · Xilinx Kintex UltraScale KU35 or KU40 FPGA
- · Rugged for industrial application
- max. 4 GByte 16-bit wide DDR4
- max. 256 MBit (32 MByte) SPI Boot Flash
- Size: 40 x 50 mm
- · 3 mm mounting holes for skyline heat spreader
- B2B Connectors: 3 x Razor Beam, total 260 terminals
  - User I/O: HR 12, HP 132
  - Serial transceiver: GTH 8 lanes (all)
  - GT clock inputs: 2
- Clocking
  - Si5338 4 output PLL, GT and PL clocks
- 200 MHz LVDS oscillator
- All power supplies on board, single supply operation supported.
- · Evenly spread supply pins for good signal intec

Other assembly options for cost or performance optimization available plus high volume prices on request.









# **TE0741 Series**

Xilinx Kintex-7 T, Flash, 8 × Transceiver





#### Overview

Trenz Electronic TE0741 are industrial-grade FPGA modules integrating a Xilinx Kintex-7 T FPGA, 32 MByte Flash memory for configuration and operation, 8 transceivers, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips. All modules in 4 x 5 cm form factor are mechanically compatible.

All this on a tiny footprint, smaller than a credit card, at the most competitive price.

All modules produced by Trenz Electronic are developed and manufactured in Germany.

# **Key Features**

- Industrial-grade Xilinx Kintex-7 (70T, 160T, 325T and 410T) SoM
- Rugged for shock and high vibration
- 32 MByte QSPI Flash memory (with XiP support)
- Programmable clock generator
  - 2 x Transceiver clock (default 125 MHz)
  - Fabric clock (default 200 MHz)
- Plug-on module with  $2 \times 100$ -pin and  $1 \times 60$ -pin high-speed hermaphroditic strips
- 144 FPGA I/O's (65 LVDS pairs possible) available on board-to-board connectors
- 8 GTX (high-performance transceiver) lanes - GTX (high-performance transceiver) clock input
- On-board high-efficiency DC-DC converters
- 20.0 A x 1.0 V power rail
- 1.5 A x 1.8 V power rail
- System management and power sequencing
- eFUSE bit-stream encryption
- · AES bit-stream encryption
- User LEDs
- Evenly spread supply pins for good signal integrity

#### Recommended Software:

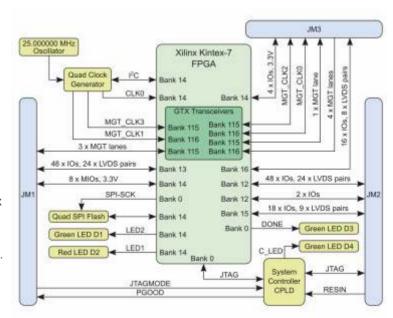
- Kintex-7 XC7K70T-2CF, Kintex-7 XC7K160T-2CF: Xilinx Vivado Webpack (free license)
- Kintex-7 XC7K325T-2CF, Kintex-7 XC7K410T-2CF: Xilinx Vivado Design Suite

Other assembly options for cost or performance optimization plus high volume prices available on request.









# **TE0710 Series**

Xilinx Artix-7 T, DDR3, Flash,  $2 \times 100$  MBit Ethernet





#### **Overview**

Trenz Electronic TE0710 are industrial-grade FPGA modules integrating a Xilinx Artix-7 T FPGA, two MBit Ethernet transceivers (physical layer), 512 Mbyte DDR3 SDRAM with 8-Bit width, 32 MByte Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stackingstrips.

All modules in 4  $\times$  5 cm form factor are mechanically compatible.

All modules produced by Trenz Electronic are developed and manufactured in Germany.

# **Key Features**

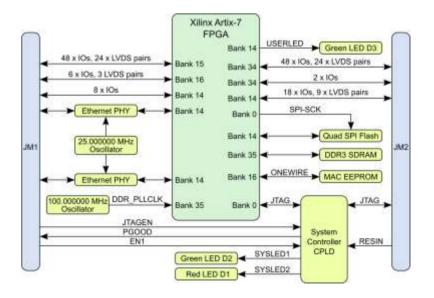
- Industrial-grade Xilinx Artix-7 (15T to 100T) SoM, supported by the free Xilinx Vivado WebPACK tool
- · Rugged for shock and high vibration
- 512 MByte DDR3 SDRAM
- Dual 100 MBit Ethernet PHY
- MAC Address EEPROM
- 32 MByte QSPI Flash memory (with XiP support)
- 100 MHz programmable MEMS oscillator
- Plug-on module with 2 × 100-pin high-speed hermaphroditic strips
- 112 FPGA I/O's (51 differential pairs) available on board-to-board connectors
- On-board high-efficiency DC-DC converters
  - 4.0 A x 1.0 V power rail
  - 1.0 A x 1.8 V power rail
  - 1.0 A x 1.5 V power rail
- · System management and power sequencing
- eFUSE bit-stream encryption
- AES bit-stream encryption
- User LED
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.









### TE0711 Series

Xilinx Artix-7 T, Flash, USB, high pin count, low cost





**Key Features** 

- Industrial-grade Xilinx Artix-7 (15T to 100T) SoM, supported by the free Xilinx Vivado WebPACK tool
- · Rugged for shock and high vibration
- 32 MByte QSPI Flash memory (with XiP support)
- 100 MHz programmable MEMS oscillator
- Plug-on module with 2 × 100-pin and 1 × 60-pin high-speed hermaphroditic strips
- 178 FPGA I/O's (84 differential pairs) available on board-to-board connectors
- On-board high-efficiency DC-DC converters
  - 4.0 A x 1.0 V power rail
  - 1.0 A x 1.8 V power rail
- System management and power sequencing
- eFUSE bit-stream encryption
- AES bit-stream encryption
- 3 user LEDs
- FTDI USB to UART/FIFO bridge
- Evenly-spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.



Trenz Electronic TE0711 are industrial-grade FPGA modules integrating a Xilinx Artix-7 T FPGA, 32 MByte Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-

number of board voltages. A large configurable I/O's is provided via rugged high-speed stacking strips. All modules in 4 x 5 cm form factor are mechanically compatible.

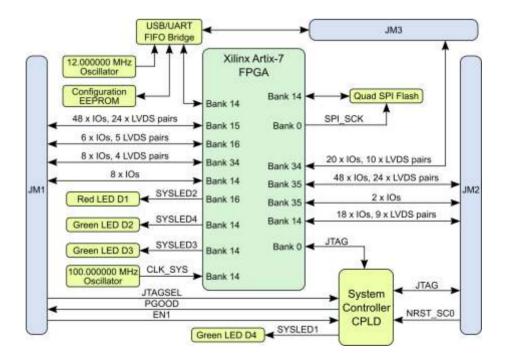
All this on a tiny footprint, smaller than a credit card, at the most competitive price.











# TE0712 Series

Xilinx Artix-7 T, DDR3, Flash, 100 MBit Ethernet, 4 x Transceiver, High pin count





# **Key Features**

- Industrial-grade Xilinx Artix-7 (15T to 200T)
   SoM, supported by the free Xilinx Vivado WebPACK tool
- · Rugged for shock and high vibration
- 1 GByte DDR3 SDRAM
- 100 MBit Ethernet PHY
  - MAC Address EEPROM
- 32 MByte QSPI Flash memory (with XiP support)
- Programmable clock generator
  - Transceiver clock (default 125 MHz)
  - Fabric clock (default 200 MHz)
- Plug-on module with 2 × 100-pin and 1 × 60-pin high-speed hermaphroditic strips
- 158 FPGA I/O's (78 differential pairs) available on board-to-board connectors
- 4 GTP (high-performance transceiver) lanes
  - GTP (high-performance transceiver) clock input
- On-board high-efficiency DC-DC converters
  - 12 A x 1.0 V power rail
  - 1.5 A x 1.8 V power rail
  - 1.5 A x 1.5 V power rail
- System management and power sequencing
- eFUSE bit-stream encryption
- · AES bit-stream encryption
- User LED
- Evenly spread supply pins for good signal integrity

Other assembly options for cost or performance optimization plus high volume prices available on request.

#### **Overview**

Trenz Electronic TE0712 are industrial-grade FPGA modules integrating a Xilinx Artix-7 T FPGA, a Megabit Ethernet transceiver (physical layer), 1 Gigabyte DDR3 SDRAM with 32-Bit width, 32 Megabyte Flash memory for configuration and operation, and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged high-speed stacking strips. All modules in 4x5 cm form factor are mechanically compatible.

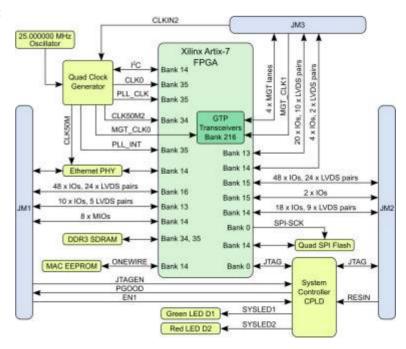
All this on a tiny footprint, smaller than a credit card, at the most competitive price.











### **TE0713 Series**

Xilinx Artix-7 T, DDR3L, USB 3.0, 4 GTP lanes





#### **Overview**

The Trenz Electronic TE0713 is an industrial-grade FPGA module integrating a Xilinx Artix-7 FPGA, USB 3.0 to FIFO bridge, 1 GByte of DDR3L SDRAM, 32 MByte Flash memory for configuration and operation, and powerful switching-mode power supplies for all on-board voltages. Numerous configurable I/O's are provided via rugged high-speed strips. Modules in 4 x 5 cm form factor are fully mechanically and largely electrically compatible among them. All this on a tiny footprint, smaller than a credit card, at the most competitive price.

All modules produced by Trenz Electronic are developed and manufactured in Germany.

#### Extended device life cycle



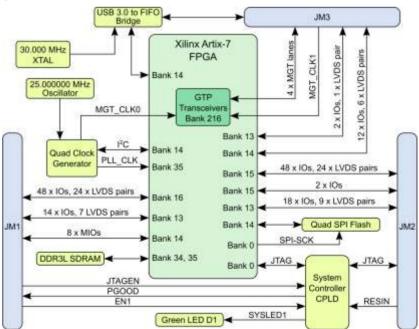




# **Key Features**

- Xilinx Artix-7 (15T to 200T) SoM
- Both industrial and commercial temperature ranges available
- Rugged for high shock and high vibration resistance
- 1 GByte DDR3L 32-bit SDRAM
- 32 MByte QSPI Flash memory (with XiP support)
- USB 3.0 to FIFO interface bridge
- Programmable clock quad generator
  - GTP transceiver clock (default 125 MHz)
  - Fabric clock (default 200 MHz)
- Plug-on module with 2 x 100-pin and 1 x 60-pin highspeed hermaphroditic strips
- 152 FPGA I/O's (75 differential pairs) available via B2B connectors
- 4 GTP (multi Gigabit transceiver) lanes
- External clock input for GTP transceivers via B2B connector
- On-board high-efficiency DC-DC converters
- · System management and power sequencing
- eFUSE bit-stream encryption
- AES bit-stream encryption
- User configurable LED
- Evenly spread supply pins for good signal integrity.

Other assembly options for cost or performance optimization plus high volume prices available on request.



# **TE0714 Series**

Xilinx Artix-7, 16 MByte Flash, 4 x GTP Transceiver





#### **Overview**

The Trenz Electronic TE0714 is an industrial-grade FPGA module integrating a Xilinx Artix-7 (A15T, A35T, A50T), 16 MByte Flash memory for configuration and operation and powerful switch-mode power supplies for all on-board voltages. A large number of configurable I/O's is provided via rugged highspeed stacking strips.

All this on a tiny footprint, smaller than a credit card, at the most competitive price.

All modules produced by Trenz Electronic are developed and manufactured in Germany.



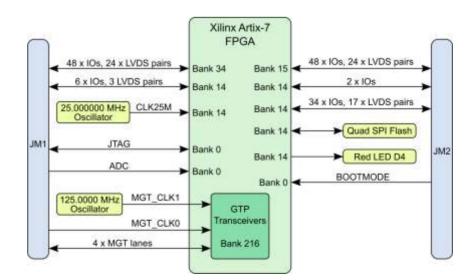




# **Key Features**

- Xilinx Artix-7 (A15T, A35T, A50T)
- · Rugged for shock and high vibration
- 16 MByte QSPI Flash memory
- Dimensions: 4 x 3 cm
- · Differential MEMS Oscillator for GT Clocking
- MEMS Oscillator for PL Clocks (option)
- Plug-on module with 2 × 100-pin high-speed hermaphroditic strips
  - 144 FPGA I/O's (max 68 differential)
  - XADC Analog Input
  - 4 GTP (high-performance transceiver) lanes
  - GT Reference Clock input
  - Optimized I/O and power pins for good signal integrity
- · On-board high-efficiency DC-DC converters
- eFUSE bit-stream encryption (AES)
- · One user LED

Other assembly options for cost or performance optimization plus high volume prices available on request.





# **TE0725 / 725LP Series**

Xilinx Artix-7, 32 MByte Flash, 87 IO's, 2x 50 Pin Headers 2.54 mm Pitch



#### TE0725 Series

Xilinx Artix-7, 32 MByte Flash, 87 IO's, 2x 50 Pin Headers 2.54 mm Pitch



#### **Overview**

The Trenz Electronic TE0725 is a low cost small-sized FPGA module integrating a Xilinx Artix-7 (15T - 100T) and 32 MByte Flash memory for configuration and operation. The 2 x 50 pin header with a 2.54 mm standard pitch fits perfect on a breadboard.

All modules produced by Trenz Electronic are developed and manufactured in Germany.





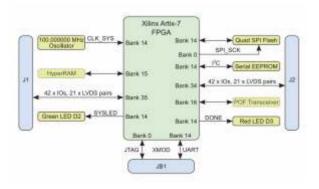




# **Key Features**

- Xilinx Artix-7 15T up to 100T
- commercial temperature grade (industrial on request)
- · 32 MByte Flash memory
- 2 x 50 pin headers with 2.54 mm pitch, ideal for breadboard use
- 87 IO's (42 + 42 + 3)
- 100 MHz system clock
- I2C EEProm
- 3.3V single supply with on board voltage regulators
- Size 73 x 35 mm
- JTAG connector
- 2 LEDs
- optional HyperRAM (8 to 32 MByte)
- · optional Fiber Optic module

Other assembly options for cost or performance optimization available or high volume prices on request.



#### ΓΕ0725LP

Xmod Form-Factor, FT2232H, Lattice X02-256 CPLD, 4 Position DIP Switch



#### **Overview**

The Trenz Electronic TE0725LP-01-100-2C is a low cost small-sized FPGA module integrating a Xilinx Artix-7 (15T - 100T) and 32 MByte Flash memory for configuration and operation. The 2 x 50 pin headers with a 2.54 mm standard pitch are perfect

for bread-board or low cost dual layer PCB.

All modules produced by Trenz Electronic are developed and manufactured in Germany.





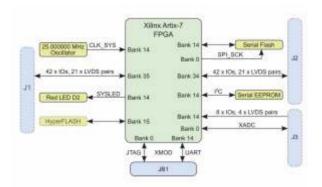




# **Key Features**

- Xilinx Artix-7 XC7A100T
- commercial temperature grade (industrial on request)
- · 32 MByte Flash memory
- 2 x 50 pin headers with 2.54 mm pitch, ideal for breadboard use
- 3.3 V or optional 1.8 V single supply with on board voltage regulators
- 95 I/O's (42 + 42 + 3 + 8)
- 25 MHz system clock (100 MHz can be customized on request)
- I2C EEPROM
- JTAG/UART connector
- One user LED
- 7.3 x 3.5 cm form factor
- Optional HyperRAM (8 32 MByte) or HyperFlash

Other assembly options for cost or performance optimization plus high volume prices available on request.



# TE0790 / TE0790-L

Xmod Form-Factor, FT2232H, Lattice X02-256 CPLD, 4 Position DIP Switch





#### **Overview**

Xmod-USB-X is a universal USB adapter with 2 channels based on FTDI FT2232H USB2 HS Interface chip.

In the consigned default configu-ration Port A is JTAG and Port B is a serial interface. FT2232H port A and B are connected to small on-board programmable CPLD to allow flexible application specific remappings of FT2232H functions into 8 user I/O pins of single Xmod 12 x 8 Module.

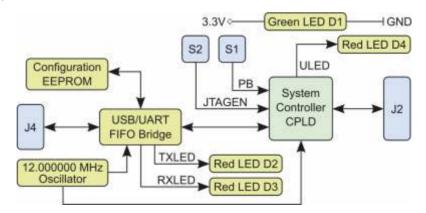
Minimum PCB area on base board to support JTAG function  $5 \times 10 \text{ mm}$  (does not include mounting hole space).

TE0790 is compatible with Xilinx Tools in contrast to the TE0790-01L, that can be used flexibly.

All modules produced by Trenz Electronic are developed and manufactured in Germany.

# **Key Features**

- · Xmod form-factor
  - Supported base slots: 6 x 2, 8 x 4, 10 x 6, 12 x 8, 5 x 2, 5 x 3
  - Size: 20 x 25 mm
  - M3 mounting hole
- FT2232H
  - Channel B RX/TX LED's (on top, not visible from front)
  - Mini-USB connector (more rugged then micro-USB)
  - 93C56 EEPROM
- Lattice XO2-256 CPLD
  - On board programmable using Lattice tools
  - 8 universal I/O pins
  - VCCIO either 3.3 V or user supplied (1.8 to 3.3V)
  - Red user LED (front visible)
  - 12 MHz clock from on-board Oscillator
- LDO for optional USB power
- Green Power-on LED (front visible)
- User button (front accesible)
- · 4 position DIP switch
  - Choose CPLD program mode
  - FTDI EEPROM disable (not implemented in PCB REV 1)
  - Use VIO same as VCC
  - Use VCC from USB





# TE Carrier Boards electronic built for Trenz Electronic micromodules with 4 x 5 cm form factor

The Trenz Electronic Carrier Boards are base-boards for 4 x 5 SoMs, which exposes the modules B2B-connector-pins to accessible connectors and provides a whole range of on-board components to test and evaluate Trenz Electronic 4 x 5 SoMs.

#### **TE0701**

- · Overvoltage-, undervoltage- and reversed- supply-voltage-protection
- · Barrel jack for 12 V power supply
- · Carrier Board System-Controller CPLD
- · Mini CameraLink connector
- · RJ45 Gigabit Ethernet MagJack
- FPGA Mezzanine Card (FMC) connector
- USB JTAG- and UART interface with Mini-USB connector
- HDMI transmitter with HDMI connector.
- 8 x user LED's, 2 x user push buttons, 2 x DIP switch
- PMOD connectors, Micro SD card socket and Micro-USB interface



- 2 x VG96 backplane connectors (mounting holes and solder pads)
- SDIO port expander with voltage-level translation
- · Micro SD card socket
- 4 x user LED's, 1 x user-push button, 2 x user configurable DIP switches
- Mini USB connector (USB JTAG and UART interface)
- · RJ45 Gigabit Ethernet socket with 4 integrated LED's.
- · USB host connector
- Barrel jack for 5 V power supply input
- DC-DC step-down converter for 3.3 V power supply
- USB JTAG and UART interface



#### **TE0705**

TE0705 is a "downgraded" version of TE0701. As little as possible has been changed in functionality except the functionality that was removed.

Changes from TE0701

- PMOD connectors changed to IDC headers
- · HDMI removed
- · CL connector removed
- · USB connector position changed
- 5 pin header support added on both USB interfaces
- 12 V DC power input connector changed to different type
- FMC connector removed and replaced by two dual row 100 mil pin headers

# **TE0706**

- VG96 backplane connector and 50-pin IDC male connector socket
- SDIO port expander with voltage-level translation
- Micro SD card socket and a USB type A connector
- 1 x user push button, user configurable DIP switch
- 1 x RJ45 Gigabit Ethernet MagJack
- 1 x Ethernet PHY
- Barrel jack for 5 V power supply input
- DC-DC step- down converter for 3.3 V power supply
- JTAG pins on 12-pin header
- 3 x VCCIO selection jumper



# **TEBA0841**

Mainly for the use with TE0841 and TE0741 modules.

- XMOD (TE0790) pin header
- · SFP connector
- · Micro USB
- 1 x pin header 16 pol. (JTAG, MGT-CLK, boot mode, RST, IOs)
- 1 x pin header 10 pol. (SD IOs)
- 2 x pin headers 50 pol. (FPGA bank IOs and power)
- 1 x pin header for FPGA bank power VCCIOA and 1 x for VCCIOD
- LDO voltage regulator 3.3 V to 2.5 V
- 2 x user LED's (Red/Green)







# TE Carrier Boards electronic custom built for specific Trenz Electronic micromodules

Following Trenz Electronic Carrier Boards are custom-built base boards for specific Trenz Electronic SoMs, which exposes the module's B2B-connector-pins to accessible connectors and provides a whole range of on-board components to test and evaluate Trenz Electronic SoMs.

#### **TEBF0808**

- · Mini-ITX form factor
- ATX power supply connector (Important 12 V only supply required)
- optional 12 V standard power plug
- USB 3.0 with USB 3.0 HUB
- · Gigabit Ethernet RJ45
- MicroSD Card (bootable) and eMMC (bootable)
- PCle slot one PCle lane (16 Lane connector)

- · Displayport Single Lane
- One SATA Connector
- Dual SFP+
- FMC HPC slot (1.8 V max VCCIO)
- Fan connectors, PC enclosure, FMC fan
- Intel front panel- and HDA audio-connector
- CAN FD transceiver (10 pin IDC connector)
- 20 pins ARM JTAG connector (PS JTAG0)
- · One Samtec FireFly (4 GT lanes bidir)
- One Samtec FireFly connector for reverse loopback



- Trenz TE0728 module socket (3 x Samtec SEM connectors 80 pins)
- 2 x RJ45 Ethernet
- · SD card slot
- · Power supply with DC jack
- 3 x user LED's (red/yellow/green)
- · User push button



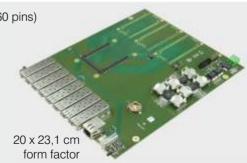
#### **TEB0729**

- Trenz TE0729 module socket (2 x Samtec BTE/BSE connectors 120 pins)
- 5 V board supply via DC jack
- 3 x RJ45 Ethernet
- 1 x MicroUSB and 1 x SD card connector
- 1 x 128K I2C CMOS Serial EEPROM
- 1 x 2K I2C Serial EEPROM
- XMOD (TE0790) pin header
- 2 x pin header FPGA bank power supply
- 1 x VBat pin header and 2 x VG96 pin header
- 1 x user push button, 1 x LED (red), user switch FPGA boot mode



#### **TEB0745**

- Trenz TE0745 module socket (3 x Samtec ST5 connectors 160 pins)
- 24 V power supply over ARKZ950/2 connecting terminal
- XMOD (TE0790) Pin Header (JTAG / UART)
- 1 x EMI Network Filter
- microSD connector
- RJ45 Ethernet connector
- USB Host connector
- 8 x SFP connector
- 6 x pin header 50 pol. (FPGA bank I/O's and power)
- 6 x pin header 12 pol. (FPGA bank I/O's and power)



# **TEBA0714**

- Trenz TE0714 module socket (2 x Samtec LSHM connectors 100 pins)
- XMOD (TE0790) pin header
- 1 x pin header 16 pol. (JTAG, MGT-CLK, boot mode, XADC, I/O's)
- 1 x pin header 10 pol. (I/O's)
- · SFP connector
- LDO voltage regulator 3.3 V to 2.5 V
- 2 x user LED's (red/green) and 1 x LED (red)
- 2 x pin headers 50 pol. (FPGA bank I/O's and power)
- 1 x pin header for FPGA bank power VCCIO34 (1.8 VOUT, 2.5 V, 3.3 VOUT)
- 1 x pin header for FPGA bank power V\_CFG (1.8 VOUT, 2.5 V, 3.3 VOUT)







# **Module series comparison table**

	TE0710	TE0711	TE0712	TE713	TE0714	TE0715	GigaZee TE0720
Device family	ARTIX.	ARTIX. <sup>7</sup>	ARTIX?	ARTIX. <sup>7</sup>	ARTIX:	ZYNQ.	ZYNQ.
Device list	35T 50T 75T 100T	35T 50T 75T 100T	35T 50T 75T 100T 200T	15T - 200T	15T 35T 50T	Z-7015 Z-7030	Z-7020
Form factor/size	form X factor	form X tactor	form X tactor	form X factor	form X factor	form X factor	form X factor
Connectors	2 × Samtec LSHM	3 × Samtec LSHM	3 × Samtec LSHM	3 x Samtec LSHM	2 x Samtec LSHM	3 × Samtec LSHM	3 x Samtec LSHM
Programmable logic family	Artix-7	Artix-7	Artix-7	Artix-7	Artix -7	Z-7015: Artix-7 Z-7030: Kintex-7	Artix-7
Processing system	MicroBlaze	MicroBlaze	MicroBlaze	MicroBlaze	MicroBlaze	2 x Cortex A9	2 x Cortex A9
SDRAM capacity [MByte] max	512 DDR3	-	1024 DDR3	1024 DDR3L	-	1024 DDR3	1024 DDR3
Flash [MByte]	32	32	32	32	16	32	32
EEPROM	-	FTDI User EEPROM	MAC	-	-	MAC	MAC
еММС	-	-	-	-	-	-	4 - 64 GByte
Ethernet PHY	2 x 100 MBit	-	100 MBit	-	-	1 GBit	1 GBit
USB PHY	-	USB 2 UART/FIFO		USB 3.0	-	USB 2.0 OTG	USB 2.0 OTG
Total I/O	112	178	158	152	144	132 + 14 MIO	152 + 14 MIO
GBit transceivers	-	-	4 x GTP	4 x GTP	4 x GTP	Z-7015: 4 x GTP Z-7030: 4 x GTX	-
Other features	-	-	Programmable Clock Generator	Programmable Clock Generator	-	Programmable Clock Generator, RTC	RTC

TE0728	TE0729	TE0741	TE0745	TE0782	TE803	TE0808 "UltraSOM+"	TE820	TE0841
ZYNQ.	ZYNQ.	KINTEX?	ZYNQ	ZYNQ.	ZYNQ. UltraSCALE+	ZYNQ. UltraSCALE+	ZYNQ. UltraSCALE+	KINTEX, UtraSCALE
Z-7020 (automotive)	Z-7020	70T 160T 325T 410T	Z-7030 Z-7035 Z-7045	Z-7035 Z-7045 Z-7100		ZU9EG (ZU6CG, ZU9CG, ZU6EG, ZU9EG, ZU15EG)		KU35 KU40
form X factor	5.2 * 10711 X factor 7.6	form X factor 5	5.2 form X factor 7.6	8.5 form X factor 8.5	5.2 form X factor 7.6	5.2 form X factor 7.6	form X factor	form X factor
3 x Samtec SEM	2 x Samtec BTE	3 × Samtec LSHM	3 x Samtec ST5	3 x Samtec QTH	4 x Samtec ST5	4 x Samtec ST5	3 x Samtec LSHM	3 x Samtec LSHM
Artix-7	Artix-7	Kintex-7	Kintex-7	Kintex-7	UltraScale+	UltraScale+	UltraScale+	UltraScale
2 × Cortex A9	2 × Cortex A9	MicroBlaze	2 x Cortex A9	2 x Cortex A9	4 x Cortex A53+ 2 Cortex R5	4 x Cortex A53 + 2 Cortex R5	4 x Cortex A53+ 2 Cortex R5	MicroBlaze
512 DDR3	512 DDR3	-	1024 DDR3/L	1024 DDR3	8192 DDR4	8192 DDR4	4096 DDR4	4096 DDR4
16	32	32	32	32	64	64	64	32
8 KByte	3 x MAC	-	MAC	2 x MAC + 16 KByte	-	16 KByte	-	-
	4 - 64 GByte	-	-	4 - 64 GByte	-	-	4 - 64 GByte	-
2 x 100 MBit	2 x 100 MBit, 1 GBit	-	1 GBit	2 x 1 GBit	-	-	4 - 64 GByte	1 GBit
-	USB 2.0 OTG PHY	-	USB 2.0 OTG PHY	2 x USB 2.0 OTG	-	-	USB 2.0 OTG	-
124 + 34 MIO	136 + 14 MIO	144	250 + 6 MIO	250 + 2 MIO	156 + 65 MIO	204 + 65 MIO	132 + 14 MIO	144
-	-	8 x GTX	8 x GTX	16 x GTX	PS GTR 4	4 x GTR, 16 x GTH	PS GTR 4	8 x GTH
Automotive, RTC, CAN	RTC, Cooling Solution available	Programmable Clock Generator	RTC	Programmable Clock Generator, RTC, eMMC	Programmable Clock Generator	System Monitor, Programmable Clock Generator	Programmable Clock Generator, Real Time Clock, eMMC	Programmable Clock Generator

\*modules with form factor 5.2. x 7.6 cm are not compatible with each other

#### EMC<sup>2</sup>-DP

#### PC/104 OneBank Carrier for SoC Modules

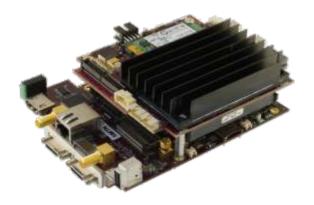
#### www.sundance.technology/emc2-dp/

Providing the base for all of our PC/104 integrated systems the EMC²-DP is a PCIe/104 OneBank® Carrier for a Trenz compatible SoC Module and also has expansion for a VITA57.1 FMC™ LPC I/O board. It has I/O pins, using a 100-way Samtec RazorBeam connector system. The add-on board, called "Sundance External Interface Connector — SEIC" contains LEDs, RS232, USB2.0, HDMI, 1Gb Ethernet and SATA. The SEIC can be customized for individual applications with bespoke connectors.

The PCIe/104 OneBank® design enables the EMC²-DP to be added to robust and rugged installations for various commercial, medical, industrial and military uses.



- PCle/104 OneBank® Carrier for Trenz SoC Modules
- PCI Express Gen 2 compatible and integrated PCI Express switch
- A number of EMC<sup>2</sup>-DP can be stacked for large I/O solutions
- Expandable with any VITA57.1 FMC I/O Module for more flexibility
- 96mm x 90 mm PC/104 Form-Factor with cableless break-out PCB connector



oi110 - DUAL CAMERALINK

#### www.sundance.technology/oi110/

A dual lane CameraLink camera interface card (SMT-FMC521) and the EMC<sup>2</sup>-DP.

The integrated Xilinx FPGA allows any CameraLink format to connected to the oi110. Additional SATA-3 expansions allow connection to large storage for future processing.

- Dual CameraLink Ports
- Dual Single SATA-3 Ports
- PoCL (Power over Camera Link) support
- Up to 85MHz data rate
- Dual Base, Single Medium Base
- Single Extended Full CL Base



oi115 - HDMI IN / OUT

#### www.sundance.technology/oi115/

An HDMI in/out module and the EMC<sup>2</sup>-DP. As such this system gives you HDMI in and out on a one bank PC/104 FPGA carrier card.

- HDMI input/output FMC module (FMC-IMAGEON)
- HDMI input
- HDMI output
- Interface for ON Semiconductor VITA image sensor modules
- Video clock synthesizer





oi710 - Quad 1.2GHz DAC www.sundance.technology/oi710/

The oi710 a combination of a DAC module (SMT-FMC211) and the EMC<sup>2</sup>-DP. As such this system gives you four 1.25GHz DAC channels on a OneBank® PC/104 FPGA carrier card.

- Quad channel DAC (TI DAC3484)
- DAC control by Artix-7 FPGA (XC7A15T)
- 16-bit DDR3 local memory for DAC data
- I<sup>2</sup>C bus for control
- External clock and triggers



EMC<sup>2</sup>-DP stackable box Coming soon!

Here's a preview of our stackable ruggedised case for the EMC<sup>2</sup>-DP. Currently in the R&D phase so please get in touch with any customisation requests!



oi816 - Octal 16BIT ADC

A combination of an eight channel ADC module (FMC168) and the EMC<sup>2</sup>-DP. This system gives you eight 16-bit ADC channels at 250MSPS on a OneBank® PC/104 FPGA carrier card.

www.sundance.technology/oi816/

- Eight-channel 16-bit 250MSPS A/D conversion
- Available as air cooled and conduction cooled
- VITA 57.1-2010 compliant
- Based on TI ADS42LB69
- Coaxial front panel inputs on SSMC connectors
- Single ended AC or DC coupled analogue input
- Flexible clock tree enables:
  - internal clock
  - internal clock locked to an external reference
  - external clock
  - external sync / 1PPS

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Xilinx development boards and kits provide an out-of-the box design solution to accelerate development time and time-to-market. Xilinx offers kits complete with evaluation boards, the Vivado Design Suite tools, IP cores, reference designs and FPGA Mezzanine Card (FMC) support – so application development begins immediately out of the box.

The Vivado Design Suite delivers a SoC-strength, IP-centric and system-centric, next generation development environment that has been built from the ground up to address the productivity bottlenecks in system-level integration and implementation.



#### Xilinx Zynq UltraScale+ MPSoC ZCU102 Evaluation Kit

The ZCU102 Evaluation Kit enables designers to jumpstart designs for Automotive, Industrial, Video and Communications applications. This kit features a Zynq UltraScale+™ MPSoC device with a quadcore ARM® Cortex-A53, dual-core Cortex-R5 realtime processors, and a Mali-400 MP2 graphics processing unit based on Xilinx's 16nm FinFET+ programmable logic fabric. The ZCU102 supports all major peripherals and interfaces enabling development for a wide range of applications.



#### **Key Features & Benefits**

- Optimized for quick application prototyping with Zyng Ultrascale + MPSoC
- DDR4 SODIMM 4GB 64-bit w/ ECC attached to Processor Subsystem (PS)
- DDR4 Component 512MB 16-bit attached to Programmable Logic (PL)
- PCle Root Port Gen2x4, USB3, Display Port & SATA
- 4x SFP+ cages for Ethernet
- 2x FPGA Mezzanine Card (FMC) interfaces for I/O expansion including 16 x 16.3 Gb/s GTH transceivers and 64 user defined differential I/O signals

This is just one example of our wide variety of Boards and Kits from Xilinx. Please have a look in our online shop for a wider selection or ask for a quote at sales@trenz.biz.



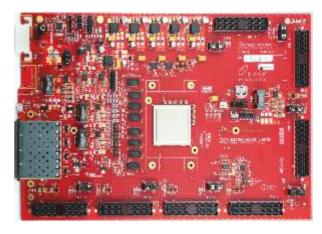
Since 1965, Tokyo Electron Device Limited (TED) has been focused on the semiconductor distribution business. Leveraging 40 years of industry experience, in 2004, TED began offering FPGA solutions under the "inrevium" brand name.

Today, inrevium offers FPGA platform solutions, market specific IP, technical support, and design services to customers worldwide. Inrevium's domain-specific expertise, market knowledge, and prequalified solutions, resulted in inrevium being adorned with the prestigious Xilinx Alliance Program Member designation.

With design and development centers in Japan, China, and Canada, and a global network of sales offices, inrevium remains uniquely positioned to provide high-value design services. In addition to services, the development centers also create market-specific multi-million gate LSI devices, FPGA evaluation boards, FMC option cards, ASIC prototyping boards, drivers, firmware, and IP, to support a wide range of worldwide applications.

#### **FPGA Evaluation Platforms**

The inrevium Xilinx FPGA Evaluation Kits are special-purpose FPGA kits intended for use by design professionals, innovating and delivering stunning 3D, Organic Light Emitting Diode (OLED), Quad HD (4K2K resolution) and many other digital display technologies, as well as 3D TV broadcasting.



KINTEX UltraSCALE: 8K4K Image Evaluation Platform

# FPGA Mezzanine Card (FMC) Standard

Developed by a consortium of companies ranging from FPGA vendors to end users, the FPGA Mezzanine Card is an ANSI standard that provides a standard Mezzanine Card form factor, connectors and modular interface to an FPGA located on a base board.

FMC is VITA 57 standard, provides a specification describing an I/O mezzanine module with connection to an FPGA or other device with reconfigurable I/O capability.



USB3.0 FMC Connectivity mezzanine card

These are just selected examples of a wide variety of FPGA boards and FMC cards from inrevium.

Please have a look in our online shop or contact us at sales@trenz.biz

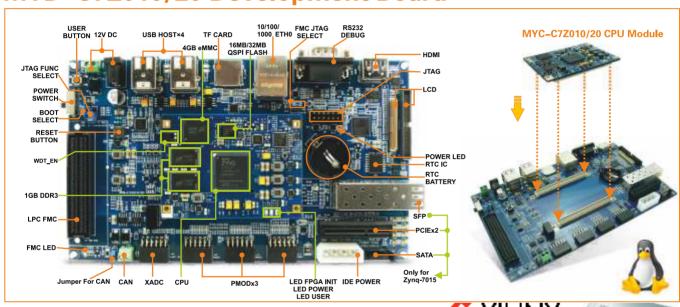
to get a quote for any available inrevium product.



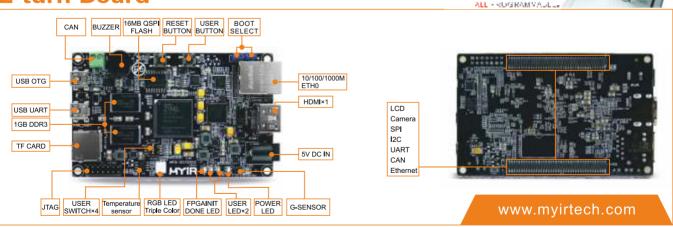
MYIR Tech Limited is a global provider of ARM hardware and software tools, design solutions for embedded applications.

MYIR is an ARM Connected Community Member and work closely with ARM and many semiconductor vendors. They sell products ranging from board level products such as development boards, single board computers and CPU modules to help with your evaluation, prototype, and system integration or creating your own applications. Their products are used widely in industrial control, medical devices, consumer electronic, telecommunication systems, Human Machine Interface (HMI) and more other embedded applications. MYIR has an experienced team and provides custom services based on many processors (especially ARM processors) to help customers make your idea a reality.

# MYD-C7Z010/20 Development Board



# **Z-turn Board**



These are just selected examples of a variety of FPGA boards from MYIR. Please have a look in our online shop or contact us at sales@trenz.biz to get a quote for any available MYIR product.

# cronologic

#### cronologic GmbH & Co. KG

cronologic offers a family of high-resolution high-throughput PCIe analog-to-digital converters (ADCs)

All models share these characteristics:

- 4 analog input channels
- Additional digital trigger and/or gating inputs
- PCIe x4 or x8 half-size boards
- Gross DMA-bandwidth of 1 Gbyte/s or 2 Gbyte/s
- · Arbitrary board combinations can be synchronized
- LEMO 00 series input connectors (adapter cabels to SMA connector available)
- The DC-offset can be shiftet to make optimal use of the ADC range for either positiv or negative pulses

	Nd	igo5G	-10	No	ligo5G	1-8	Ndigo250M-14	Violet250M-14	Violet125M-14	unit
PCIe lanes	4			4			8	8	8	-
PCIe Bandwidth	800			800			1400	1400	1400	MB/s
Analog channels	4	2	1	4	2	1	4	4	4	-
Max. Sampling Rate	1250	2500	5000	1250	2500	5000	250	250	125	Msps
Max. Bandwidth		1000			1000		120 or 700	120 or 700	60 or 450	MHz
Max. individual sample length	26	26	26		26		32	hours	hours	μs
THD	58	58	58		58		73	73	86	dBc
SNR	51	50	50		45		64	64	74	dBc
SFDR incl.	61	60	60		58		74	74	86	dBc
SFDR excl.	74	64	63		57		76	76	TBD	dBc
SINAD	50	48	48		45		64	64	72	dBc
ENOB	8.0	7.7	7.7		7.2		10.3	10.3	11.0	-
Input type and coupling	AC	single er	nded	AC :	single er	nded	DC single ended	DC single ended	DC single ended	-

# **Ndigo Series**

It has been designed to aquire trains of pulses at high repetition rates. Employing an onboard zero supression, the pulse data is recorded with pre- and post-cursors, omitting the data inbetween to reduce the requirements on bandwidth and pulse processing or averaging. There is no deadtime between samples as long as the sustained rate is lower than the available PCle bandwidth. The first available instances of this series provide 5 Gsps at 10-bit resolution and 250 Msps at 14-bit resolution.

These boards are ideally suited for applications like

- Mass Spectrometry
- Photon Counting
- Lidar
- NMR

# cronologic

#### **Violet Series**

It has been designed to continously stream samples data to host computer main memory at full rate. These boards are ideal for any applications that require unusally long samples at rates up to 250 Msps at a resolution of 14 bits.

#### Examles are:

 Software Defined RadioHigh Precision FFT Spectrum Analyzers



# **Time Tagger**

Cronologic presents a new series of low cost, mid resolution time-to-digital converters.

Two new board are available featuring 500ps to 1ns single shot resolution at highest data bandwidths.

Time Taggers are ideally suitable in applications that do not require highest single shot timing resolution, but high data acquisition rates and lowest multiple hit deadtime. These include certain types of mass spectroscopy, time correlated single photon counting (TCSPC) and frequency counting applications.



# cronologic

#### **Ndigo Crate**

With the Ndigo Crate it is possible to use up to 8 PCle boards with a PC. The connection of the external chassis to the PC happens over PCle 2 x16 for a full duplex bandwidth of 2x 8GByte/s.

The enclosure was specifically designed to operate multiple synchronized cronologic digitizer boards to create a high speed data acquisition system. It can also be used to house other DAQ cards, GPUs for high performance computing, storage adapters or networking equipment.

The extension is fully transparent. The operating system can't distinguish between boards in the PCIe expansion box and boards inside the PC itself. No drivers are required.

The slot covers are on the front side of the enclosure to easily see status information and plug in cables during operation.

The crate is delivered as a set with cable and PC link board.



Facts	Crate	Crate-3	Crate-5				
Connection to Host	PCle 2.0 x 16	PCle 2.0 x 16	PCle 2.0 x 16				
Bandwidth to Host	8 GByte/s	8 GByte/s	8 GByte/s				
Performace relative to 10Gbps Thunderbolt link	8x	8x	8x				
PCle3 16x slots with 8 lanes	-	2	2				
PCle3 16x slots with 4 lanes	-	3	3				
PCle2 16x slots with 4 lanes	8	-	-				
PCI slots 5V, 32 Bit, 33MHz	-	-	2				
PCI slots 3V, 32 Bit, 66MHz	-	2	-				
Availability	now	now	now				
Cable and link boards	included	included	included				
Cable Length	3 meters (1m, 2m and 5m upon request)						

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